

FM50

Analog Temperature Sensor

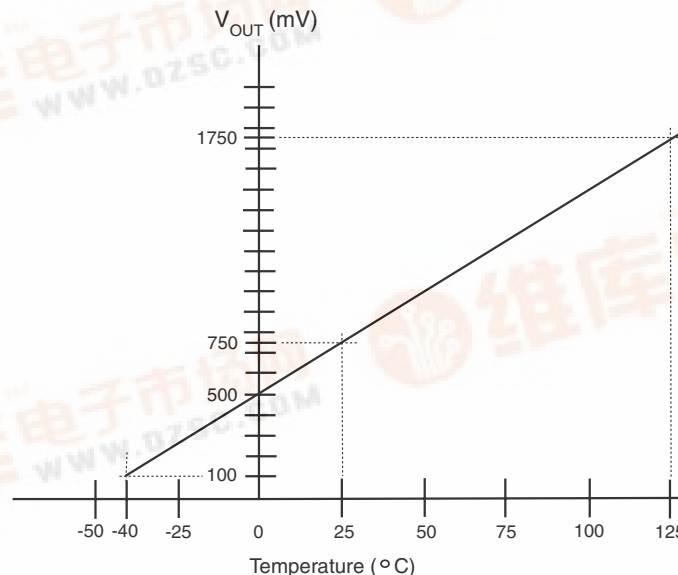
Features

- Analog output: 10 mV/°C
- Range: -40 to 125°C range:
- Accuracy: ±1°C at 25°C
- Supply Current, 170 µA max.
- Output Drive, 25 µA
- Self-heating < 0.1°C
- Operating Voltage: +2.4V to +6V

Applications

- Mobile Phones
- Computers
- Battery Management
- Office Equipment
- HVAC
- Power Supply Modules
- Disk Drives
- Automotive

Thermal Response



$$\text{Temperature (}^\circ\text{C)} = \frac{V_{\text{OUT}} - 500 \text{ mV}}{10 \text{ mV}/^\circ\text{C}}$$

FM50 Output Voltage vs. Temperature

Description

As a precision CMOS temperature sensor, the FM50 is cost-effective for accurate low-power temperature monitoring applications. Output voltage versus temperature is extremely linear. With no load, the supply current is typically 130µA. For normal operation, the load on V_{OUT} should be 100KΩ or less.

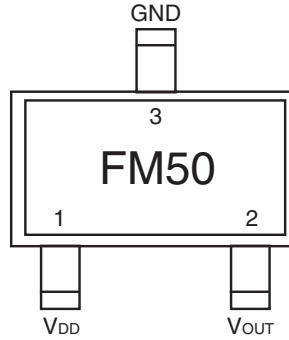
In a typical application, a remotely mounted FM50 is monitored by a microcontroller with an analog A/D converter input. Alternatively, the FM50 can drive a comparator with a high impedance input.

Accuracy is typically ±0.5°C at room temperature; and better than ±2°C from 0 to 75°C.

Package is a 3-pin SOT-23



Pin Assignments



Pin Descriptions

Pin Name	Pin No.	Type	Function
VOUT	2	Analog Output	Temperature Sense. Analog output voltage indicating temperature. $V_{OUT} = 500 + 10T(^{\circ}\text{C})$ mV
VDD	1	Power	Supply Voltage. 2.4 to 6.0V
GND	3	Power	Ground.

Absolute Maximum Ratings¹

Parameter	Min.	Typ.	Max.	Units
Supply Voltage			+7	V
Output Voltage			V _{DD} + 0.5	V
Output Current			10	μA
Operating Temperature Range ²	-50		+150	°C
Storage Temperature Range	-60		+150	°C
Lead Soldering Temperature			220	°C
ESD ²				
Human Body Model			2000	V
Machine Model			250	V

Notes:

1. Absolute maximum ratings are limits beyond which operation may cause permanent damage to the device. These are stress ratings only; functional operation at or above these limits is not implied.
2. Operating ratings are conditions for which the device is intended to be functional without specific guaranteed performance limits. For guaranteed specifications and test conditions refer to Electrical Characteristics.
3. Human Body Model: 100pF capacitor discharged through a 1.5kΩ resistor into each pin. Machine Model: 200pF capacitor discharged directly into each pin.

Electrical Characteristics⁴

Limits apply for $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ and $V_{DD} = +5.0\text{V}$ unless otherwise noted.

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Transfer Characteristic						
Sensitivity	A _{OUT}		9.7	10	10.3	mV/°C
Output at 25°C			740	750	760	mV
Accuracy ⁵		T _A = +25°C	-1	±0.5	+1	°C
		T _A = -40°C (T _{MIN})	-3.5	±1	+3.5	°C
		T _A = +125°C (T _{MAX})	-3	±1	+3	°C
Temperature Range			-40		+125	°C
Non-Linearity ⁶			-0.8		+0.8	°C
Output						
Output Voltage Range			100		1500	mV
Output Current Source	I _{ONSN}	Sensing		25		μA
	I _{ONSG}	Surge				mA
Output Current Sink	I _{OL}			50		μA
Output resistance		100kΩ load at 25°C	1		10	kΩ
Load regulation						mV/mA
Power						
Supply Voltage	V _{DD}		2.4		6.0	V
Quiescent Current	I _S	No output load			170	μA
Package						
Thermal Resistance				260		°C/W

Notes:

4. These specifications are guaranteed only for the test conditions listed.
5. Accuracy (expressed in °C) = Difference between calculated output voltage and measured output voltage. Calculated output voltage = 10mV/°C multiplied by the device's case temperature at specified conditions of temperature, voltage and power supply, added to 500mV.
6. Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.

Typical Performance Characteristics

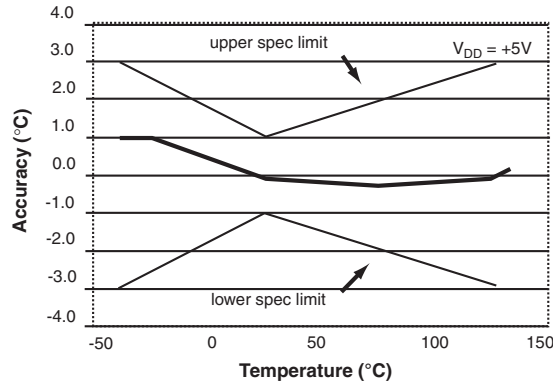


Figure 1. Accuracy vs. Temperature

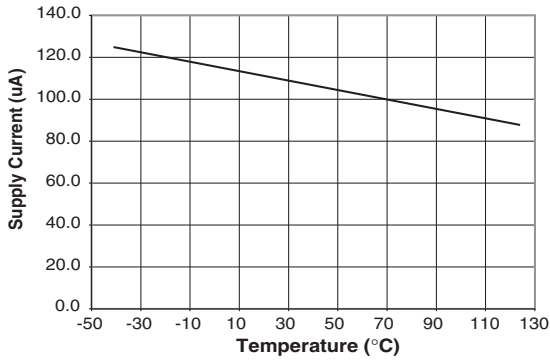


Figure 2. Typical IDD versus Temperature

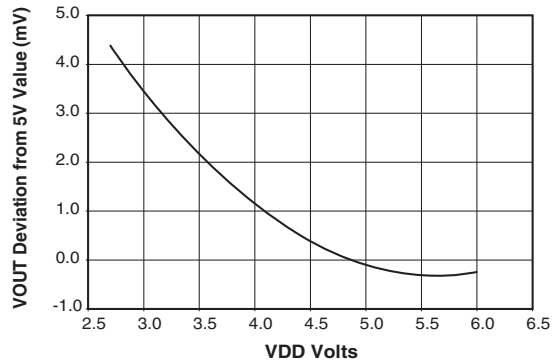


Figure 3. Typical Sensitivity to Supply Voltage

Description

Within the FM50 are a thermal diode, calibration circuits and amplifiers. Since the FM50 is calibrated at 33°C, the nominal output in mV is:

$$V_{OUT} = 830 + 10 \cdot (T - 33)$$

where T is the thermal junction temperature expressed in °C.

At 33°C, the tolerances are as follows:

1. Offset is ±3mV
2. Slope, ±0.3mV/°C

These values accommodate the specified accuracies at -40, 25 and +125°C.

Output structure of the FM50 is an n-channel CMOS transistor driving a p-channel load. Available current is typically 50 µA to ground. Series resistance is typically 7 kΩ, charging and 2 kΩ, discharging through a capacitor connected from VOUT to ground.

Following application of power to VDD, VOUT is accurate following a delay of approximately 80 msec.

Applications Information

Although the FM50 is a simple device, care must be taken to ensure that temperature is measured accurately. There are two major sources of errors:

3. Voltage errors.
4. Thermal Delay Errors.
5. Location errors

Voltage Errors

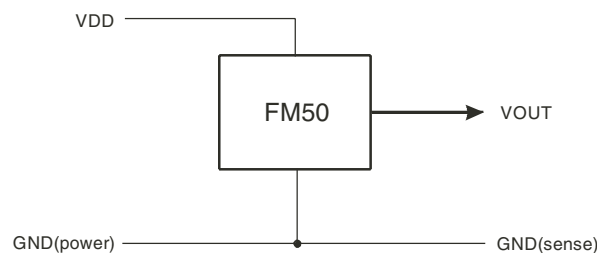


Figure 4. Recommended Electrical Connections

A Kelvin connection is recommended to avoid errors due to voltage drops in the ground connections. Although the typical 130 μ A supply current draw of the FM50 will only cause a 130 μ V error if the series resistance is 1 Ω , a 100 mA current supply to adjacent circuits can cause a 10mV drop across 100m Ω (10m Ω is a typical value for soldered joints or contact resistance), leading to a 1 $^{\circ}$ C error. For this reason, the FM50 should be Kelvin connected as shown in Figure 4.

Thermal Delay Errors

For measurement accuracy of the order of tenths of 1 $^{\circ}$ C, adequate settling time must be allowed. For a typical circuit board installation, 15 minutes should be allowed to elapse following reading of temperature within 1 - 2 $^{\circ}$ C of the expected final value. Once V_{OUT} has ceased to slew and is stable (with or without about $\pm 0.1^{\circ}$ C noise) for about 5 minutes, temperature can be calculated.

Location Errors

Position is another source of error. Even within a controlled thermal environment, changing location by a few inches can lead to errors of several tenths of 1 $^{\circ}$ C

Mounting

The FM50 can be easily mounted by gluing or cementing it to a surface. In this case, its temperature will be within about 0.2 $^{\circ}$ C of the temperature of the surface it is attached to if the ambient air temperature is almost the same as the surface temperature. If the air temperature is much higher or lower than the surface temperature, the actual temperature of the FM50 die will be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity, the backside of the FM50 die is directly attached to the GND pin. The lands and traces to the FM50 will, of course, be part of the printed circuit board, which is the object whose temperature is being measured. These printed circuit board lands and traces will not cause the FM50's temperature to deviate from the desired temperature.

Alternatively, the FM50 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the FM50 and accompanying wiring and circuits must be kept insulated and dry to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paint or dips can be used to ensure that moisture cannot corrode the FM50 or its connections.

Typical Applications Circuits

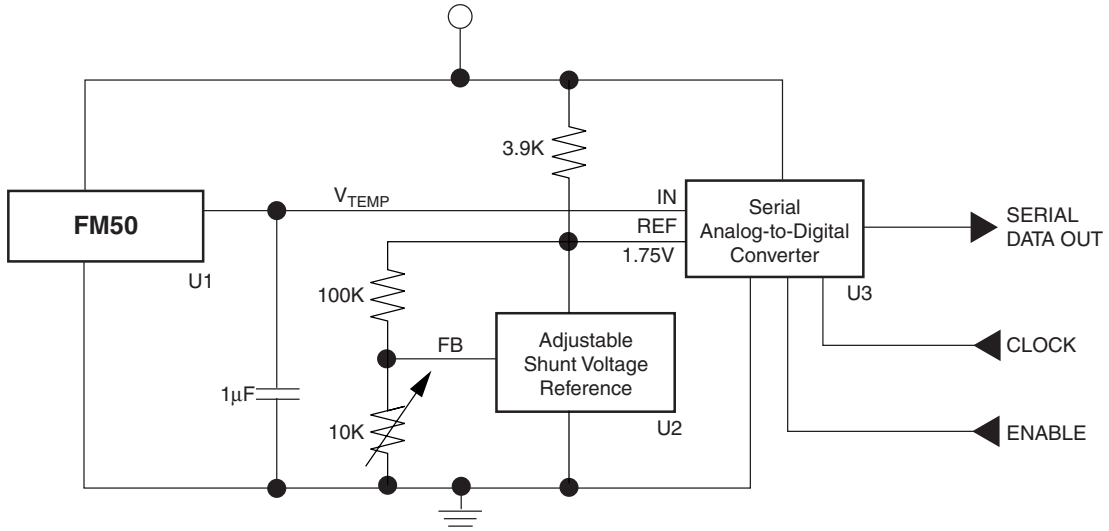


Figure 4. Serial Output Temperature to Digital Converter (Full Scale = +125°C)

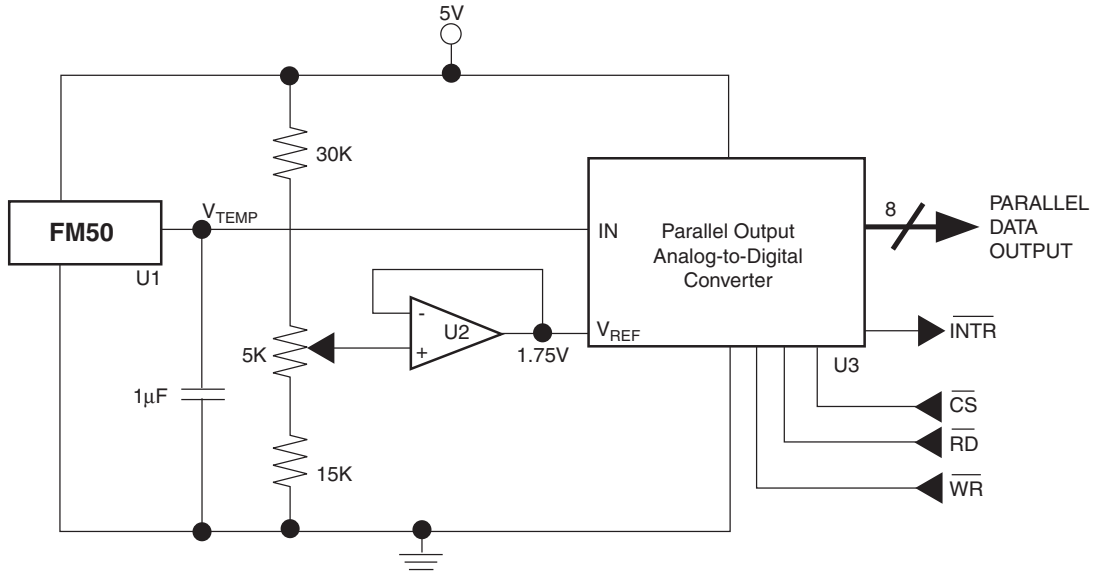


Figure 5. Parallel Output Temperature to Digital Converter (Full Scale = +125°C)

Typical Applications (continued)

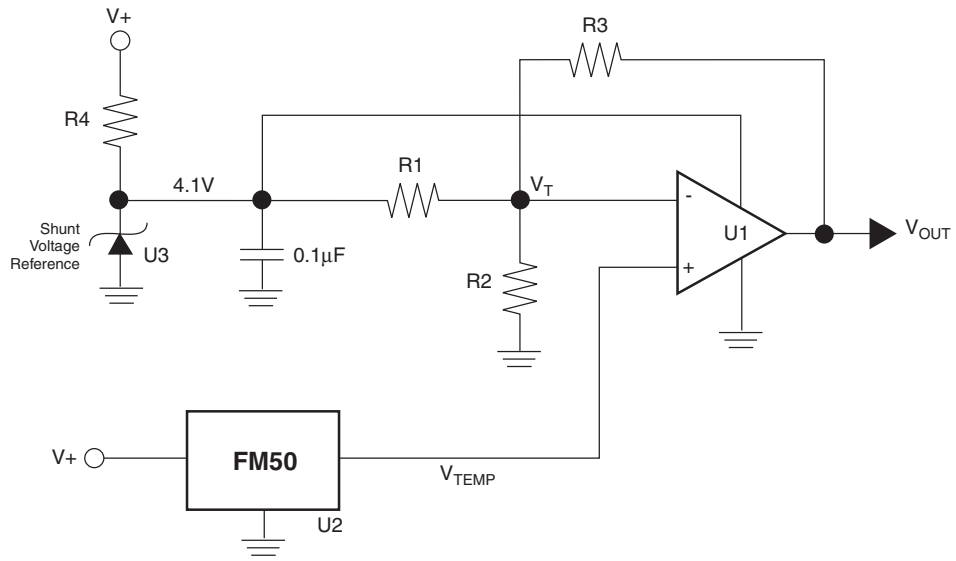
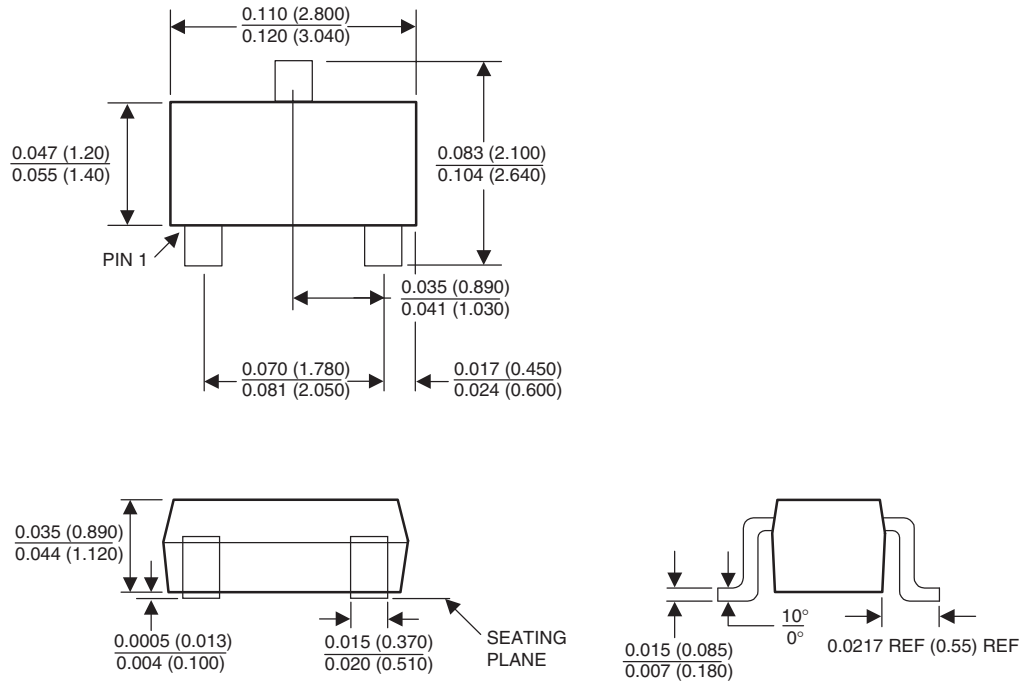


Figure 6. Thermostat/Fan Controller

Mechanical Dimensions inches (millimeters) unless otherwise noted

SOT-23 FS Package Code AU



Ordering Information

Part Number	Package	Temperature Range	Shipping
FM50S3X	3-Pin SOT-23	-40°C to +125°C	Tape and Reel, 3000 units/reel

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